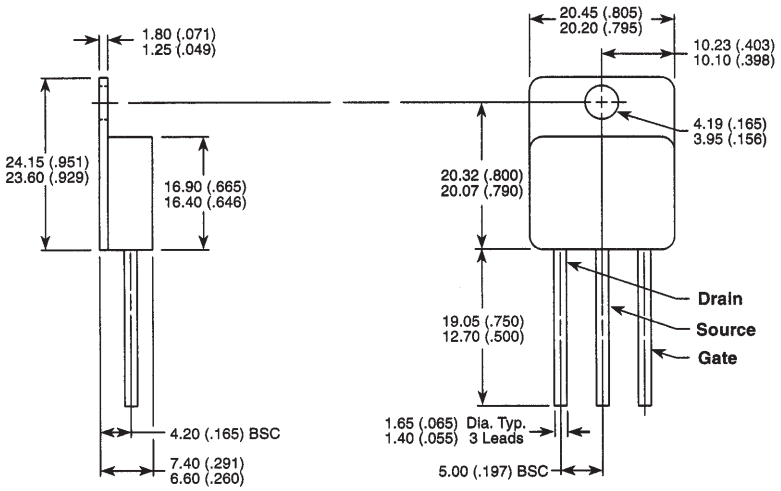
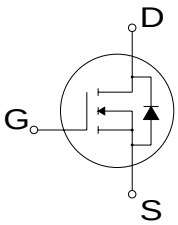
SML20W65

TO–267 Package Outline.

Dimensions in mm (inches)





N–CHANNEL ENHANCEMENT MODE HIGH VOLTAGE POWER MOSFETS

V_{DSS} 200V

$I_{D(cont)}$ 65A

$R_{DS(on)}$ 0.026Ω

- **Faster Switching**
- **Lower Leakage**
- **TO–267 Hermetic Package**

StarMOS is a new generation of high voltage N–Channel enhancement mode power MOSFETs. This new technology minimises the JFET effect, increases packing density and reduces the on-resistance. StarMOS also achieves faster switching speeds through optimised gate layout.

ABSOLUTE MAXIMUM RATINGS (T_{case} = 25°C unless otherwise stated)

V_{DSS}	Drain – Source Voltage	200	V
I_D	Continuous Drain Current [3]	65	A
I_{DM}	Pulsed Drain Current [1 3]	260	A
V_{GS}	Gate – Source Voltage	±30	V
V_{GSM}	Gate – Source Voltage Transient	±40	
P_D	Total Power Dissipation @ T_{case} = 25°C	400	W
	Derate Linearly	3.2	W/°C
T_J , T_{STG}	Operating and Storage Junction Temperature Range	–55 to 150	°C
T_L	Lead Temperature : 0.063” from Case for 10 Sec.	300	
I_{AR}	Avalanche Current [1 3] (Repetitive and Non-Repetitive)	65	A
E_{AR}	Repetitive Avalanche Energy [1]	50	mJ
E_{AS}	Single Pulse Avalanche Energy [2]	2500	

1) Repetitive Rating: Pulse Width limited by maximum junction temperature.

2) Starting T_J = 25°C, L = 1.18mH, R_G = 25Ω, Peak I_L = 65A

3) Maximum current limited by package.

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SEME LAB

SML20W65

STATIC ELECTRICAL RATINGS (T_{case} = 25°C unless otherwise stated)

	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain – Source Breakdown Voltage	V_{GS} = 0V , I_D = 250µA	200			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = V_{DSS}			65	µA
	(V_{GS} = 0V)	V_{DS} = 0.8V_{DSS} , T_C = 125°C			250	
I_{GSS}	Gate – Source Leakage Current	V_{GS} = ±30V , V_{DS} = 0V			±100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 2.5mA	2		4	V
$I_{D(ON)}$	On State Drain Current [2] [4]	V_{DS} > $I_{D(ON)}$ x $R_{DS(ON)}$ Max V_{GS} = 10V	65			A
$R_{DS(ON)}$	Drain – Source On State Resistance [2]	V_{GS} = 10V , I_D = 0.5 I_D [Cont.]			0.026	Ω

DYNAMIC CHARACTERISTICS

	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
C_{iss}	Input Capacitance	V_{GS} = 0V		8500	10200	pF
C_{oss}	Output Capacitance	V_{DS} = 25V		1950	2730	
C_{rss}	Reverse Transfer Capacitance	f = 1MHz		560	840	
Q_g	Total Gate Charge[3]	V_{GS} = 10V		290	435	nC
Q_{gs}	Gate – Source Charge	V_{DD} = 0.5 V_{DSS}		66	100	
Q_{gd}	Gate – Drain (“Miller”) Charge	I_D = I_D [Cont.] @ 25°C		120	180	
$t_{d(on)}$	Turn–on Delay Time	V_{GS} = 15V		16	32	ns
t_r	Rise Time	V_{DD} = 0.5 V_{DSS}		25	50	
$t_{d(off)}$	Turn-off Delay Time	I_D = I_D [Cont.] @ 25°C		48	72	
t_f	Fall Time	R_G = 0.6Ω		5	10	

SOURCE – DRAIN DIODE RATINGS AND CHARACTERISTICS

	Characteristic	Test Conditions	Min.	Typ.	Max.	Unit
I_S	Continuous Source Current[4]	(Body Diode)			65	A
I_{SM}	Pulsed Source Current[1] [4]	(Body Diode)			260	
V_{SD}	Diode Forward Voltage[2]	V_{GS} = 0V , I_S = – I_D [Cont.]			1.7	V
t_{rr}	Reverse Recovery Time	I_S = – I_D [Cont.] , dI_S / dt = 100A/µs		330		ns
Q_{rr}	Reverse Recovery Charge	I_S = – I_D [Cont.] , dI_S / dt = 100A/µs		5.8		µC

THERMAL CHARACTERISTICS

	Characteristic	Min.	Typ.	Max.	Unit
$R_{\theta JC}$	Junction to Case			0.31	°C/W
$R_{\theta JA}$	Junction to Ambient			40	

1) Repetitive Rating: Pulse Width limited by maximum junction temperature.
2) Pulse Test: Pulse Width < 380µS , Duty Cycle < 2%
3) See MIL–STD–750 Method 3471
4) Maximum current limited by package.

CAUTION — Electrostatic Sensitive Devices. Anti-Static Procedures Must Be Followed.

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